

后芮驷(上海)电子有限公司

Horus International Electronics Co., LTD.



SPECIFICATION FOR APPROVAL

品名	DESCRIPTION:	SMD Type Metal Power Inductor
规格	SPEC :	HRS-RCA-E252012B-SERIES
包装	PACKAGE:	卷装
客户	CUSTOMER:	

客户料号 CUSTOMER P/N:

APPROVED BY			
	王海田大田		
CUSTOMER	HORUS		

编号:





SMD Type Metal Power Inductor

P/N: RCA- E252012B-SERIES



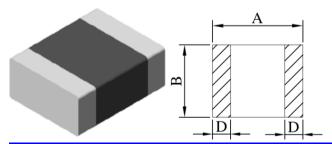
Moisture Sensitivity Level: 1

*Content in this sheet are subject to change without prior notice



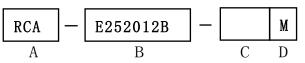
С

1. Dimension (mm):



E252012B	Dimensions
А	2.5 ± 0.2
В	2.0 ± 0.2
С	1.2 MAX
D	0.6 ± 0.2
	A B

2.Part Number:



- A: Series (RCA: For Automotive Electronics)
- B: Dimension A x B x C
- C: Inductance uH
- D: Inductance Tolerance M= \pm 20%

3. Electrical Characteristics:

Part Number	Inductance(uH) @1.0V/1MHz	$DCR(m\Omega)$ Max.	Isat(A) Max.	Irms(A) Max.
RCA-E252012B-R47M	0.47	39	5.5	5.2
RCA-E252012B-1ROM	1.0	59	4.0	3.8
RCA-E252012B-2R2M	2.2	108	3.1	2.9
RCA-E252012B-3R3M	3.3	144	2.3	2.3
RCA-E252012B-4R7M	4.7	240	1.8	1.6



nd Test Condition:				
Performance	Test Condition			
-40~+125 $^{\circ}$ C (Including self - temperature rise)				
110~+40°C ,50~60%RH (Product with taping) 240~+125°C (on board)				
e Test				
Refer to standard electrical characteristics	HP4284A, CH11025, CH3302, CH1320, CH1320S LCR Meter.			
list.	CH16502,Agilent33420A Micro-Ohm Meter.			
Approximately △L30%	Saturation DC Current (Isat) will cause L0 to drop $\ \triangle L(\%)$			
Approximately △T40℃	Heat Rated Current (Irms) will cause the coil temperature rise $\Delta T(C)$. 1.Applied the allowed DC current 2.Temperature measured by digital surface thermometer			
1				
	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles Temperature : 180±2°C (Inductor) Duration : 1000hrs Min. Measured at room temperature after placing for 24±2 hrs.			
	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Condition for 1 cycle Step1: $40\pm2^{\circ}$ 30min Min.(Inductor) Step2: $125\pm2^{\circ}$ transition time 1min MAX. Step3: $125\pm2^{\circ}$ 30min Min. Step4: Low temp. Transition time 1min MAX. Number of cycles: 1000 Measured at room temperature after placing for 24±2 hrs.			
Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	Preconditioning:Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles 1.Baked at50°C for 25hrs, measured at room temperature after placing for 4 hrs. 2.Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 3.Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs, down the part of 0 to 55°C for 25hrs, then keep at -10°C for 3hrs 4.Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55°Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.			
-	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles Humidity : 8543% R.H, Temperature : 85°C ±2°C Duration: 1000hrs Min with 100% rated current. Measured at room temperature after placing for24±2hrs			
	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Temperature : 180±2℃ (Inductor) Duration : 1000hrs Min. With 100% rated current. Measured at room temperature after placing for24±2hrs			
Appearance : No damage.	Inspect device construction, marking and workmanship. Electrical Test not required.			
According to the product specification size measurement	According to the product specification size measurement			
Appearance ÷ No damage.	Add aqueous wash chemical - OKEM clean or equivalent.			
Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value Q : Shall not exceed the specification value.	Type Peak value (g's) Normal Duration (D) (ms) Wave form Velocity Change (Vi)ft/sec SMD 100 6 Half-sine 12.3			
	-40~+125°C (Including self - temperature rise) 110~+40°C,50~60%RH (Product with taping) 2. 40~+125°C (on board) > Test Refer to standard electrical characteristics list. Approximately △L30% Approximately △T40°C Impedance : No damage. Impedance : within±15% of initial value Inductance : within±15% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value Appearance : No damage. Appearance : No damage.			



Item	Performance	Test Condition			
Vibration		IPC/JEDEC J-STD-020DClassification Reflow Profiles Oscillation Frequency: 10~2K~10Hz for 20 minute Equipment : Vibration checker Total Amplitude:1.52mm±10% Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations) •			
Resistance to Soldering Heat	Appearance:No damage. Impedance:within±15% of initial value Inductance:within±10% of initial value	Test condition : Temperature () Time(s) Temperature Number of heat cycles			
Ticat	Q : Shall not exceed the specification value.	260±5(solder temp) 10±1 25mm/s ±6 mm/s 1			
Thermal shock (AEC-Q200)	RDC : within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Condition for 1 cycle Step1 : -40±2°C 15±1min(Inductor) Step2 : 125±2°C 15±1min Number of cycles : 300 Measured at room temperature after placing fo24±2hrs			
ESD	Appearance:No damage.	ip epsilon 10% t _r Time (ns)			
Solder ability	More than 95% of the terminal electrode should be covered with solder ∘	Steam Aging: 8 hours ± 15 min Preheat: 150 , 60sec. Solder: Sn96.5% Ag3% Cu0. 5% Temperature: 245±5			
Electrical Characterization	Refer Specification for Approval	Summary to show Min, Max, Mean and Standard deviation.			
Flammability	Electrical Test not required.	V-0 or V-1 are acceptable.			
Board Flex	Appearance : No damage	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Place the 100mm X 40mm board into a fixture similar to the one shown in below Figure with the component facing down. The apparatus shall consist of mechanical means to apply a force which will bend the board (D) x = 2 mm minimum. The duration of the applied forces shall be 60 (+ 5) sec. The force is to be applied only once to the board.			
		Printed circuit board under tost			
Terminal Strength (SMD)	Appearance : No damage	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020D Classification Reflow Profiles With the component mounted on a PCB with the device to be tested, apply a 17.7 N (1.8 Kg) force to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested. racius 0.5 mm DUT wide thickness shear force			



5.Soldering and Mounting:

(1) Soldering

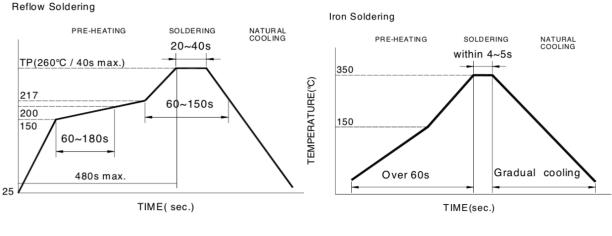
Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. The terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools. Note. If Use Wave soldering is there will be some risk. Re-flow soldering temperatures below 240 degrees, there will be unwitting risk

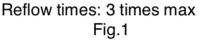
(2) Solder re-flow:

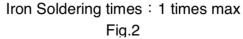
Recommended temperature profiles for lead free re-flow soldering in Figure 1.

(3) Soldering Iron:

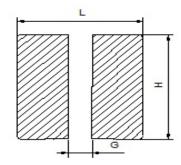
Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. for Iron Soldering in Figure 2.







(4) Recommend PC Board Pattern(mm)



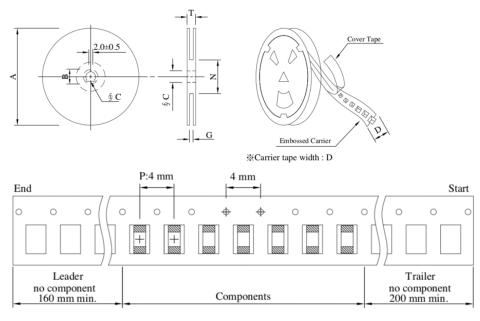
L(mm)	G(mm)	H(mm)
2.7	0.8	2.2



6.Package Information:

Packaging Quantity: 3000pcs/Reel

Reel Dimension:

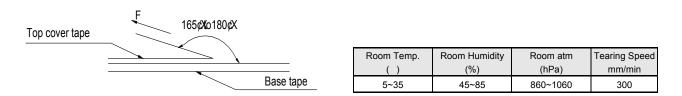


User direction of feed

Unit:mm

Style	А	В	С	D	G	N	Т
07 - 08	180 ±2.0	21±0.8	13	8	8.4 ^{+2.0} -0	60 ⁻⁰	14.4+0

Tearing Off Force:



The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions(referenced ANSI/EIA-481-D-2008 of 4.11 standard).

Application Notice

Storage Conditions To maintain the solder ability of terminal electrodes:

- 1. RDM products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
- 2. Temperature and humidity conditions: -10~ 40 $^{\circ}\mathrm{C}$ and 30~70% RH.
- 3. Recommended products should be used within 6 months from the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- · Transportation1.Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

Modify records:					
Version	Page	Description			
V01	N/A	New issued			